PREPARED BY:	DATE:			SPEC. No.	ED-96197XB
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APPROVED BY:	DATE:	ELECTRONIC CO GROUP SHARP O	i	REPRESENT	TATIVE DIVISION
J. Ypsnikama :	2n 21 203	SPECIFIC			
		Of ECIFIC	2111011	OPIO-ELEC	TRONIC DEVICES DIV.
		SPECIFICATION FOI OTOCOUPLER No. PC814	Business dealing PC814X PC814X		
Please do not r 2. When using th in these specif for any damag	reproduce or cau is product, pleas ication sheets, a e resulting from	ude materials protected se anyone to reproduce se observe the absolute s well as the precaution use of the product which these specification sh	maximum ratings and smentioned below. So the does not comply with	s consent. d the instructio Sharp assumes ith the absolute	ns for use outlined no responsibility maximum ratings
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		nsult with a Sharp sale on of the above three pa	-	ere are any que	stions
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DATE			Engine	nent General ering Dept.,II	_
BY			Opto-El	ectronic Devid M Group	ces Div.

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1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC814X.

2. Outline

Refer to the attached drawing No. CY8543K02.

3. Ratings and characteristics

Refer to the attached sheet, page 4 to 6.

4. Reliability

Refer to the attached sheet, page 7.

5. Outgoing inspection

Refer to the attached sheet, page 8.

6. Supplement

- 6.1 Isolation voltage shall be measured in the following method.
 - (1) Short between anode and cathode on the primary side, and between collector and emitter on the secondary side.
 - (2) The dielectric withstand tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.
 (It is recommended that the isolation voltage be measured in insulation oil.)

6.2 Collector current (Ic) Delivery rank table

(" \bigcirc " mark indicates business dealing name of ordered product)

Ordered product	Business dealing name	Rank mark	Ic (mA)	
	PC814X	A or no mark	0.2 to 3.0	
	PC814X1	A	0.5 to 1.5	

Test conditions
$I_F = \pm 1 \text{mA}$
V_{CE} =5 V
Ta=25℃

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6.3 This Model is approved by UL.

Approved Model No.: PC814X

UL file No.: E64380

- 6.4 This photocoupler is designed for AC input..
- 6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This device \cdot component shall not contain the following materials. Also, the following materials shall not be used in the production process for this device \cdot component.

 $\begin{array}{c} \text{Materials for ODS} \ : \ \text{CFC}_S, \ \text{Halon, Carbon tetrachloride,} \\ 1.1.1\text{-Trichloroethane} \ (\text{Methylchloroform}) \end{array}$

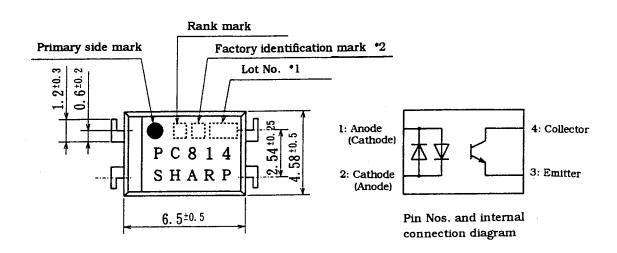
6.7 Brominated flame retardants

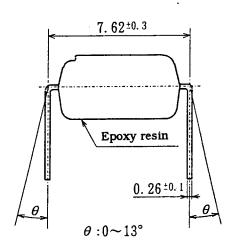
Specific brominated flame retardants such as the $\ensuremath{\mathsf{PBBO}}_S$ and $\ensuremath{\mathsf{PBB}}_S$ are not used in this device at all.

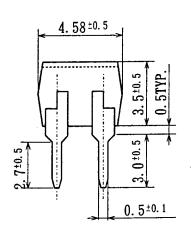
7. Notes

Refer to the attached sheet-1-1,2.

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*1) 2-digit number shall be marked according to DIN standard.

*2) Factory identification mark shall be or shall not be marked.

	UNIT: 1/1 mm
Name PC814 Outline Dimensions (Business dealing name : PC814X)	
Drawing	CY8543K02

Product mass: Approx. 0.25g

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3. Ratings and characteristics

3.1 Absolute maximum ratings

Ta=25℃

Parameter		Symbol	Rating	Unit
	*l Forward current	I _F	±50	mA
Input	*2 Peak forward current	I _{FM}	±1	A
	*1 Power dissipation	P	70	mW
	Collector-emitter voltage	V _{CEO}	35	v
Output	Emitter-collector voltage	V _{ECO}	6	V
	Collector current	Ic	50	mA
	*1 Collector power dissipation	Pc	150	mW
*1 Total power dissipation		Ptot	200	mW
Operating temperature Storage temperature *3 Isolation voltage *4 Soldering temperature		Topr	-30 to +100	င
		Tstg	-55 to +125	င
		Viso	5	kVrms
		Tsol	260	Ĉ

^{*1} The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4.

^{*2} Pulse width ≤ 100 μ s, Duty ratio : 0.001 (Refer to Fig. 5)

^{*3} AC for 1 min, 40 to 60%RH

^{*4} For 10 s

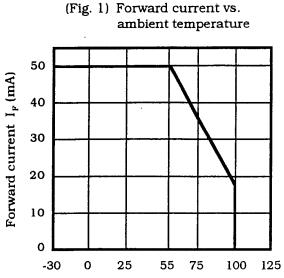
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3.2 Electro-optical characteristics

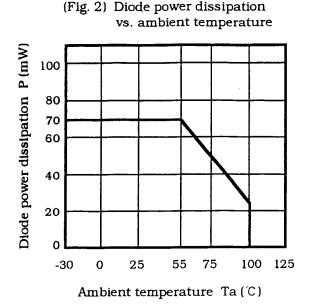
Ta=25℃

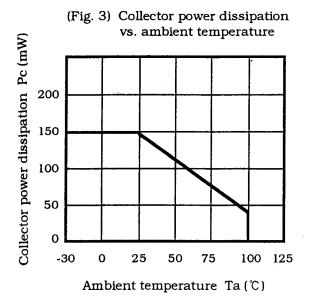
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward voltage	V _F	I _F =±20mA	-	1.2	1.4	v
Input	Peak forward voltage	V_{FM}	I _{FM} =±0.5A	-	-	3.0	v
	Terminal capacitance	Ct	V=0, f=1kHz	-	50	250	pF
	Dark current	I _{CEO}	V _{CE} =20V, I _F =0	-	-	100	nA
Output	Collector-emitter breakdown voltage	$\mathrm{BV}_{\mathrm{CEO}}$	Ic=0.1mA I _F =0	35	-	-	V
	Emitter-collector breakdown voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_{\rm E}$ =10 μ A, $I_{\rm F}$ =0	6	-	-	V
	Collector current	I c	$I_{F}=\pm 1 \text{ mA}$ $V_{CE}=5V$	0.2	-	3.0	mA
	Collector-emitter saturation voltage	. V _{CE(sat)}	I _F =±20mA Ic=1mA	-	0.1	0.2	V
Transfer	Isolation resistance	Riso	DC500V 40 to 60%RH	5×10 ¹⁰	1011	-	Ω
teristics	Floating capacitance	Cf	V=0, f=1MHz	-	0.6	1.0	pF
	Cut-off frequency	fc	V_{CE} =5V, Ic=2mA R _L =100 Ω , -3dB	15	80	-	kHz
	Response time (Rise)	tr	V _{CE} =2V Ic=2mA	-	4	18	μS
	Response time (Fall)	tf	$R_L=100 \Omega$	-	3	18	μs

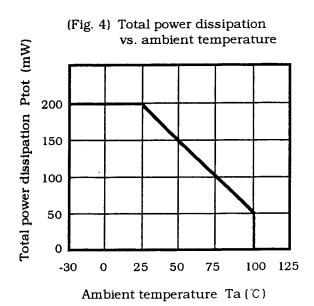
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Ambient temperature Ta (℃)







(Fig. 5) Peak forward current vs. duty ratio Peak forward current I_{FM} (mA) 2000 1000 500 200 100 50 5 10-32 5 10 2 5 10 5 10° Duty ratio

Pulse width ≦100 μs Ta=25℃

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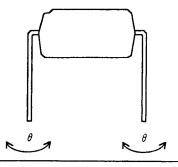
4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level: 90% LTPD: 10%/20%

Test Items	Test Conditions *1	Failure Judgement Criteria	Samples (n) Defective(C)
Solderability *2	230°C, 5 s		n=11, C=0
Soldering heat	260℃, 10 s		n=11, C=0
Terminal strength (Tension)	Weight : 5N 5 s/each terminal		n=11, C=0
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	$V_{F}>U\times1.2$ $I_{CEO}>U\times2$	n=11, C=0
Mechanical shock	15000m/s^2 , 0.5ms 3 times/ $\pm X$, $\pm Y$, $\pm Z$ direction	$I_{\rm CEO} > 0.7$ $I_{\rm C} < L \times 0.7$	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4min 200m/s ² 4 times/ X, Y, Z direction	$V_{CE(sat)}>U\times1.2$	n=11, C=0
Temperature cycling	1 cycle -55°C to +125°C (30min) (30min) 20 cycles test		n=22,C=0
High temp. and high humidity storage	+60°C, 90%RH, 1000h	U : Upper specification limit	n=22,C=0
High temp. storage	+125℃, 1000h	L : Lower specification	n=22,C=0
Low temp. storage	-55℃, 1000h	limit	n=22,C=0
Operation life	I _F =±50mA, Ptot=200mW Ta=25℃, 1000h		n=22,C=0

- *1 Test method, conforms to JIS C 7021.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- *3 Terminal bending direction is shown below.



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- 5. Outgoing inspection
 - 5.1 Inspection items
 - (1) Electrical characteristics

$$V_{F}$$
, I_{CEO} , $V_{CE(sat)}$, Ic, Riso, Viso

- (2) Appearance
- 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL (%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25

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PC814X Attach sheet-1-1

Precautions for Photocouplers

1 For cleaning

(1) Solvent cleaning: Solvent temperature 45°C or less

Immersion for 3 min or less

(2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs

by cleaning bath size, ultrasonic power

output, cleaning time, PWB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting

the ultrasonic cleaning.

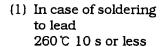
(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

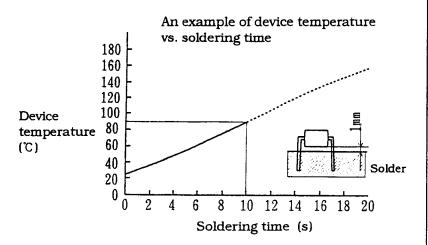
In case when the other solvent is used, there are cases that the packaging resin is eroded. Please use the other solvent after thorough confirmation is performed in actual using condition.

2. The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit with considering the degradation of the light emission power of the LED. (50%/5years)

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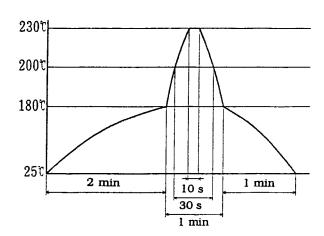
3. Precautions for Soldering Photocouplers





(2) If solder reflow:

It is recommended that only one soldering be done at the temperature and the time within the temperature profile as shown in the figure before.



(3) Other precautions

An infrared lamp used to heat up for soldering may cause a localized temperature rise in the resin. So keep the package temperature within that specified in Item (2). Also avoid immersing the resin part in the solder.

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